

SANYO Semiconductors

· Large current

· Slim package

· Protection diode in

DATA SHEET

An ON Semiconductor Company

N-Channel Silicon MOSFET

ATP212 — General-Purpose Switching Device **Applications**

Features

- Low ON-resistance
- 4V drive
- · Halogen free compliance

Specifications

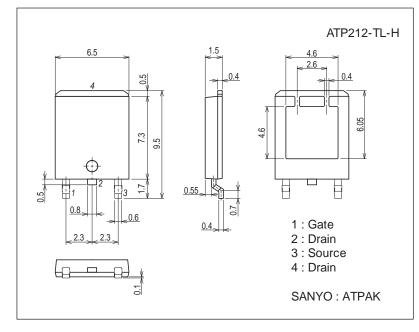
Absolute Maximum Ratings at Ta=25°C

| Parameter | Symbol | Conditions | Ratings | Unit |
|------------------------------------|--------|------------------------|-------------|------|
| Drain-to-Source Voltage | VDSS | | 60 | V |
| Gate-to-Source Voltage | VGSS | | ±20 | V |
| Drain Current (DC) | ID | | 35 | А |
| Drain Current (PW≤10μs) | IDP | PW≤10µs, duty cycle≤1% | 105 | А |
| Allowable Power Dissipation | PD | Tc=25°C | 40 | W |
| Channel Temperature | Tch | | 150 | °C |
| Storage Temperature | Tstg | | -55 to +150 | °C |
| Avalanche Energy (Single Pulse) *1 | EAS | | 19 | mJ |
| Avalanche Current *2 | IAV | | 18 | А |

Note :*1 VDD=10V, L=100µH, IAV=18A *2 L≤100µH, Single pulse

Package Dimensions

unit : mm (typ) 7057-001



Product & Package Information

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- Package : ATPAK
- JEITA, JEDEC
- Minimum Packing Quantity : 3,000 pcs./reel

Packing Type: TL

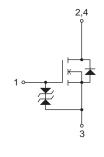


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Electrical Connection



SANYO Semiconductor Co., Ltd. http://semicon.sanyo.com/en/network



Ratings

typ

max

min

60

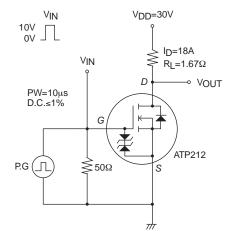
Unit

V

| Electrical Characteristics at Ta=25°C | | | | | | |
|---------------------------------------|-----------------------|--|--|--|--|--|
| Parameter | Symbol | Conditions | | | | |
| Drain-to-Source Breakdown Voltage | V(BR)DSS | ID=1mA, VGS=0V | | | | |
| Zero-Gate Voltage Drain Current | IDSS | V _{DS} =60V, V _{GS} =0V | | | | |
| Gate-to-Source Leakage Current | IGSS | V _{GS} =±16V, V _{DS} =0V | | | | |
| Cutoff Voltage | V _{GS} (off) | V _{DS} =10V, I _D =1mA | | | | |
| | | | | | | |

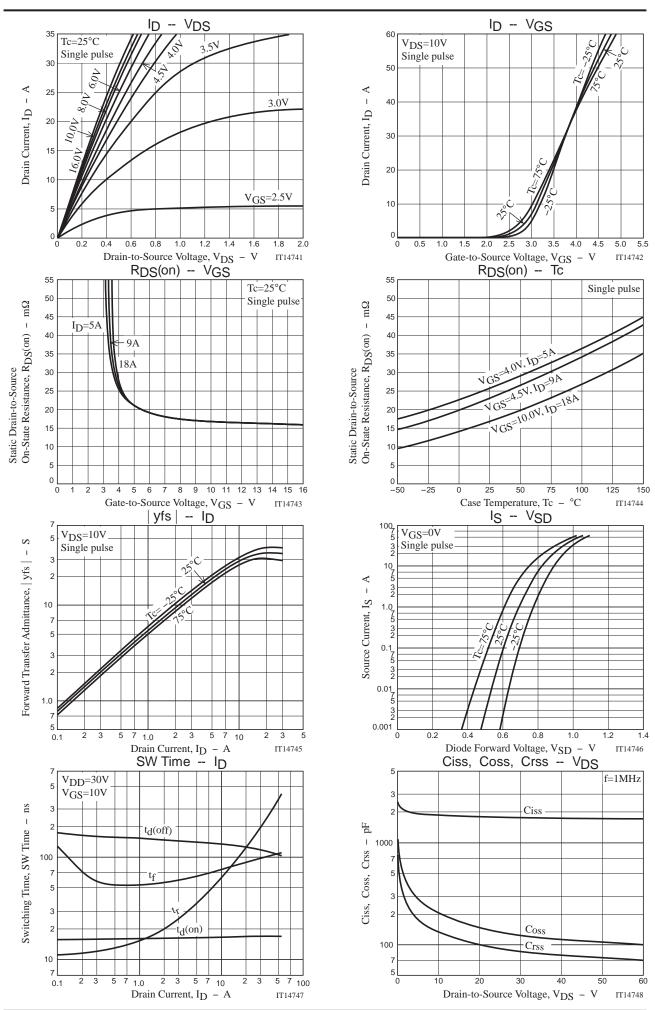
| Zero-Gate Voltage Drain Current | IDSS | V _{DS} =60V, V _{GS} =0V | | | 1 | μΑ |
|--|-----------------------|---|-----|------|-----|----|
| Gate-to-Source Leakage Current | IGSS | V _{GS} =±16V, V _{DS} =0V | | | ±10 | μΑ |
| Cutoff Voltage | VGS(off) | V _{DS} =10V, I _D =1mA | 1.2 | | 2.6 | V |
| Forward Transfer Admittance | yfs | VDS=10V, ID=18A | | 35 | | S |
| | R _{DS} (on)1 | ID=18A, VGS=10V | | 17 | 23 | mΩ |
| Static Drain-to-Source On-State Resistance | R _{DS} (on)2 | ID=9A, VGS=4.5V | | 23 | 33 | mΩ |
| | R _{DS} (on)3 | ID=5A, VGS=4V | | 25 | 37 | mΩ |
| Input Capacitance | Ciss | | | 1820 | | pF |
| Output Capacitance | Coss | V _{DS} =20V, f=1MHz | | 150 | | pF |
| Reverse Transfer Capacitance | Crss | | | 100 | | pF |
| Turn-ON Delay Time | t _d (on) | | | 16 | | ns |
| Rise Time | tr | | | 110 | | ns |
| Turn-OFF Delay Time | td(off) | See specified Test Circuit. | | 125 | | ns |
| Fall Time | tf | | | 87 | | ns |
| Total Gate Charge | Qg | | | 34.5 | | nC |
| Gate-to-Source Charge | Qgs | V _{DS} =30V, V _{GS} =10V, I _D =35A | | 6.5 | | nC |
| Gate-to-Drain "Miller" Charge | Qgd | 1 | | 6.8 | | nC |
| Diode Forward Voltage | VSD | I _S =35A, V _{GS} =0V | | 0.96 | 1.2 | V |

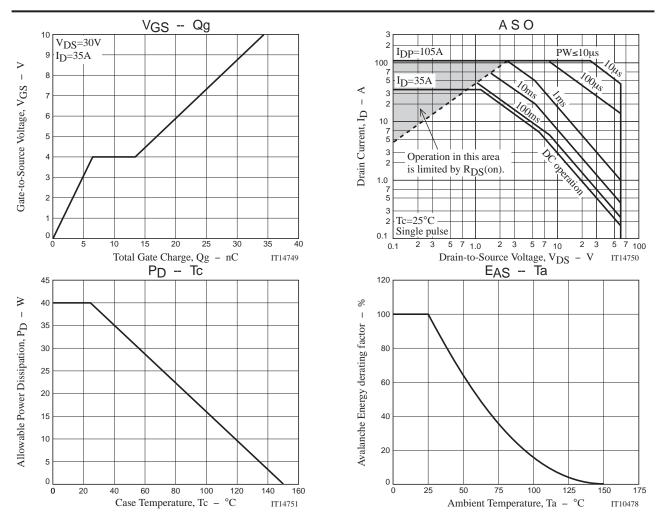
Switching Time Test Circuit



Ordering Information

| Device | Package | Shipping | memo | |
|-------------|---------|----------------|--------------------------|--|
| ATP212-TL-H | ATPAK | 3,000pcs./reel | Pb Free and Halogen Free | |



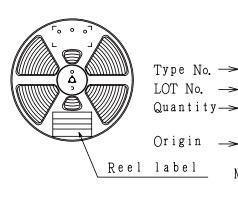


Taping Specification

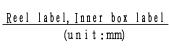
ATP212-TL-H

1. Packing Format (TL)

| Package Name | Carrier Tape Maximum Number of Packing f | | | | o r m a t | |
|--------------|--|-------|-----------|-----------|--------------------------|--------------------------|
| Lackage Mame | Туре | Reel | Inner box | Outer box | INNER BOX SD-C-18 | OUTER BOX SD-A-18 |
| | | | | | 1 reels contained | 5 inner boxes contained |
| ATPAK | ATP | 3,000 | 3,000 | 15,000 | Dimensions:mm (external) | Dimensions:mm (external) |
| | | | | | 340×340×28 | 355×355×165 |



<u>Packing</u> method



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Outer box label It is a label at the time of factory shipments. The form of a label may change in physical distribution process.

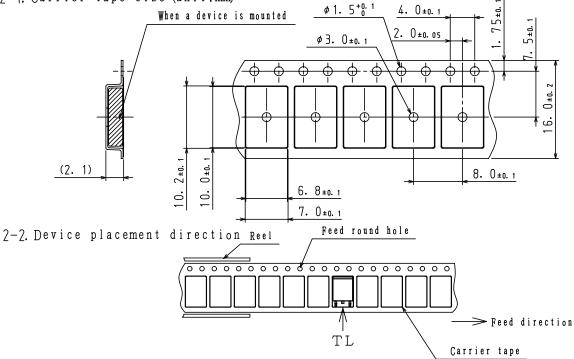
| | L | - | 108 |
|----|---|-----------------------|---|
| | | - | - |
| | | TYPE CODE | *00000000* |
| | | TYPB | 00000000 |
| | | QTY | 0, 000 pcs (1) Lead free # |
| 80 | | LOT | 00000000 |
| | | PACKAGE | 00000000 |
| - | | SPECIAL ASSEMBLY:* | *Z0722005310C* **** (DIFFUSION: *****) |

NOTE (1) The LEAD FREE 🕷 description shows that the surface treatment of the terminal is lead free.

| Label | JEITA Phase |
|-------------|----------------|
| LEAD FREE 3 | JEITA Phase 3A |
| LEAD FREE 4 | JEITA Phase 3 |

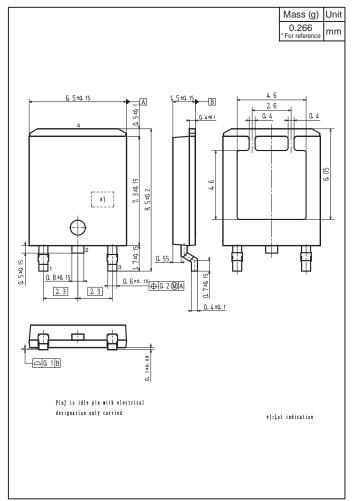
2. Taping configuration

2-1. Carrier tape size (unit:mm)

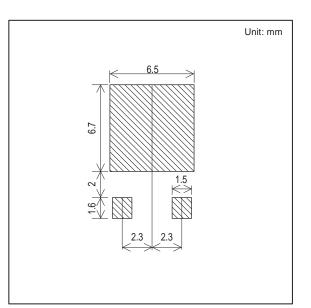


The one erectrode terminals on feed hole side TL

Outline Drawing ATP212-TL-H



Land Pattern Example



Note on usage : Since the ATP212 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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